

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current, per IEC 61000-4-5	IPP	5.5	Α	I/O to V _{SS} , 8/20µs
Peak Pulse Power, per IEC 61000-4-5	P _{PP}	55	W	I/O to V _{SS} , 8/20µs
ESD Protection – Contact Discharge, per IEC 61000-4-2	V _{ESD_CONTACT}	±16	kV	I/O to V _{SS}
ESD Protection – Air Discharge, per IEC 61000-4-2	V _{ESD_AIR}	±16	kV	I/O to V _{SS}
Operating Temperature	T _{OP}	-55 to +85	°C	_
Storage Temperature	T _{STG}	-55 to +150	°C	_

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation Typical (Note 5)	P _D	500	mW
Thermal Resistance, Junction to Ambient Typical (Note 5)	$R_{ hetaJA}$	250	°C/W

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V_{RWM}	_	_	5.5	V	$I_R=1$ mA, , I/O to V_{SS}
Reverse Current	I _R	_	1	0.5	μA	$V_R = 5.5V$, I/O to V_{SS}
Reverse Breakdown Voltage	V_{BR}	6			V	$I_R = 1 \text{mA}$, I/O to V_{SS}
Forward Clamping Voltage	V_{F}	-1.0	-0.85	_	V	$I_F = -15 \text{mA}$, I/O to V_{SS}
Reverse Clamping Voltage (Note 6)	Vc	_	9.4	11	V	$I_{PP} = 5.5A$, I/O to V _{SS} , 8/20 μ s
ESD Clamping Voltage	V _{ESD}		9		V	TLP, 10A, tp = 100ns, I/O to V _{SS}
Dynamic Reverse Resistance	R _{DIF-R}	_	0.25		Ω	TLP, 10A, tp = 100ns, I/O to V_{SS}
Dynamic Forward Resistance	R _{DIF-F}	_	0.25	$\overline{}$	Ω	TLP, 10A, tp = 100ns, V _{SS} to I/O
Channel Input Capacitance	C _{I/O}	_	4	0.75	pF	$V_{I/O} = 2.5V$, $V_{SS} = 0V$, $f = 1MHz$
Delta C _{I/O}	CI/OMAX-CI/OMIN	_	0.04	_	pF	C _{I/OMAX} -C _{I/OMIN}

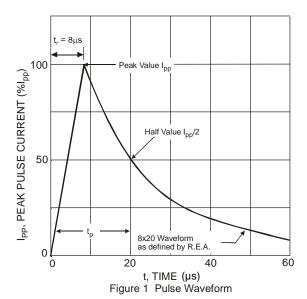
Notes:

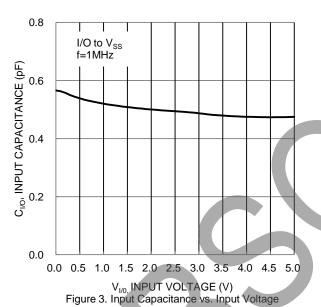
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

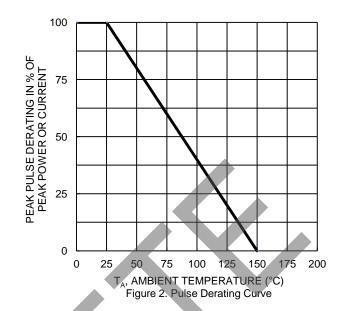
 6. Clamping voltage value is based on an 8x20µs peak pulse current (I_{PP}) waveform.

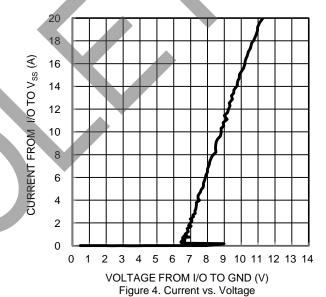










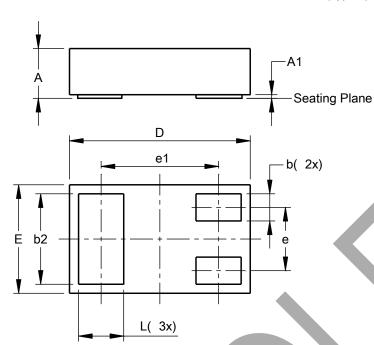




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X3-DSN1006-3 (Type B)



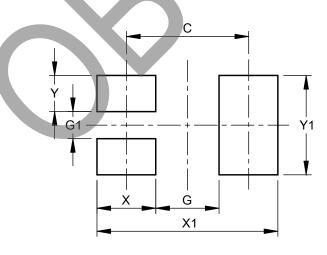
	X3-DSN1006-3					
Dim	(Type B) Dim Min Max Typ					
Α	0.250	0.300	0.275			
A1	0.00	0.02	0.01			
b	0.130	0.170	0.150			
b2	0.480	0.520	0.500			
D	0.975	1.025	1.00			
E	0.575	0.625	0.600			
е			0.350			
e1			0.650			
L	0.230	0.270	0.250			
All Dimensions in mm						

Note 7: Device side walls are electrically active bare silicon. Avoid contact of solder or flux on the side walls during the PCB assembly process.

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X3-DSN1006-3 (Type B)



Dimensions	Value (in mm)		
С	0.70		
G	0.30		
G1	0.20		
X	0.40		
X1	1.10		
Y	0.25		
Y1	0.70		



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